IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application

Applicant(s): J.M. Brennan et al.
Case: 2-81-1-4
Serial No.: 10/773,614
Filing Date: February 6, 2004
Group: 2823
Examiner: Brook Kebede

> I hereby certify that this paper is being deposited on this date with the U.S. Postal Service as first class mail addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.
>
> Signature: _Lisa L. Vulpis_ Date: March 28, 2006

Title: Semiconductor Device Configured for Reducing Post-Fabrication Damage

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AMENDMENT TRANSMITTAL

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Submitted herewith is the following document relating to the above-identified patent application:

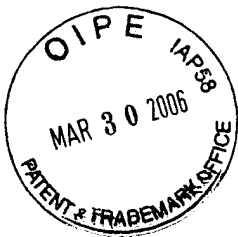(1) Amendment After Final Rejection Under 37 C.F.R. §1.116.

There is no additional fee due in conjunction with the Amendment. In the event of any non-payment or improper payment of a required fee, the Commissioner is hereby authorized to charge or to credit **Ryan, Mason & Lewis, LLP Deposit Account No. 50-0762** as required to correct the error.

Respectfully submitted,

Wayne L. Ellenbogen
Reg. No. 43,602
Attorney for Applicant(s)
Ryan, Mason & Lewis, LLP
90 Forest Avenue
Locust Valley, NY 11560
(516) 759-7662

Date: March 28, 2006

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AMENDMENT AFTER FINAL REJECTION UNDER 37 C.F.R. §1.116

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the final Office Action dated December 28, 2005, Applicants submit herewith the following Amendment for entry in the above-identified application: